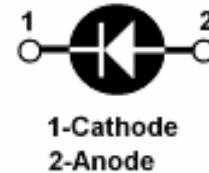
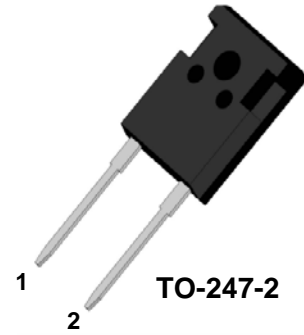


PRODUCT FEATURES

- Ultrafast Recovery Time
- Low Recovery Loss
- Soft Reverse Recovery Characteristics
- Low Leakage Current
- Low Forward Voltage
- High Surge Current Capability

APPLICATIONS

- Freewheeling, Snubber, Clamp
- Inversion Welder
- PFC
- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper
- UPS



DESCRIPTION

FRED from MacMic utilizes advanced processing techniques to achieve ultrafast recovery times and higher forward current. Its soft recovery characteristics and high reliability suit for wide industrial applications.

ABSOLUTE MAXIMUM RATINGS

$T_C=25^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Values	t
V_R	Maximum D.C. Reverse Voltage		1200	V
V_{RRM}	Maximum Repetitive Reverse Voltage			
$I_{F(AV)}$	Average Forward Current	$T_C=80^{\circ}\text{C}$	60	A
$I_{F(RMS)}$	RMS Forward Current	$T_C=80^{\circ}\text{C}$	84	
I_{FSM}	Non Repetitive Surge Forward Current	$T_J=45^{\circ}\text{C}, t=10\text{ms}, 50\text{Hz}, \text{Sine}$	500	
P_D	Power Dissipation		312	W
T_J	Junction Temperature		-55 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range		-55 to +125	$^{\circ}\text{C}$
Torque	Module to Sink	Recommended (M3)	1.1	Nm
R_{thJC}	Junction to Case Thermal Resistance		0.4	$^{\circ}\text{C}/\text{W}$
Weight			6	g

ELECTRICAL CHARACTERISTICS

$T_C=25^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	t
I_{RM}	Maximum Reverse Leakage Current				10	μA
					1	mA
V_F	Forward Voltage			2.8	3.3	V
				2.3		
trr	Reverse Recovery Time ($I_F = 1\text{A}, di_F/dt = -200\text{A}/\mu\text{s}, V_R = 30\text{V}$)			30	35	ns
trr	Reverse Recovery Time ($I_F = 0.5\text{A}, I_R=1\text{A}, I_{RR} = 0.25\text{A}$)			65	80	ns
trr	Reverse Recovery Time			75		ns
I_{RRM}	Maximum Reverse Recovery Current			9		A
trr	Reverse Recovery Time			180		ns
I_{RRM}	Maximum Reverse Recovery Current			17		A

MM60FU120B

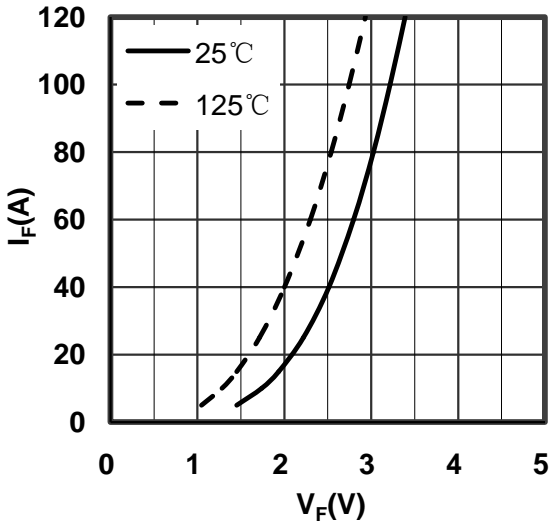


Figure 1. Forward Voltage Drop vs Forward Current

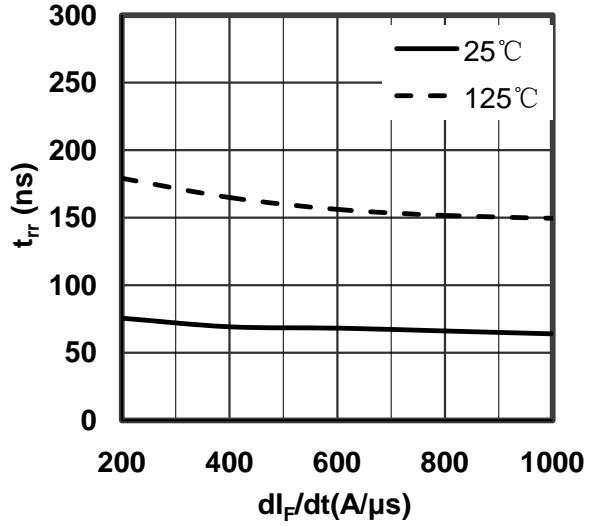


Figure 2. Reverse Recovery Time vs di_F/dt

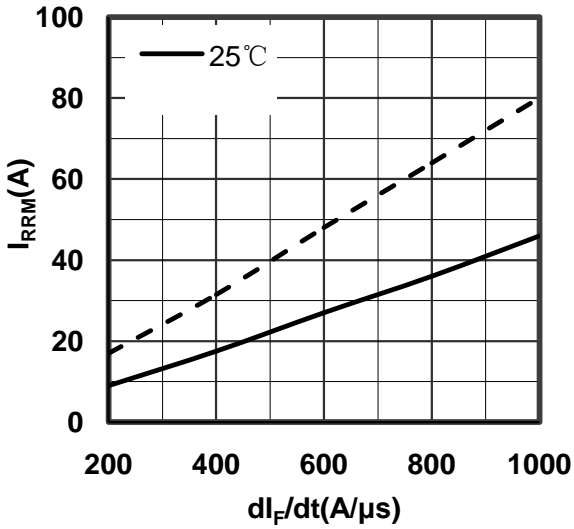


Figure 3. Reverse Recovery Current vs di_F/dt

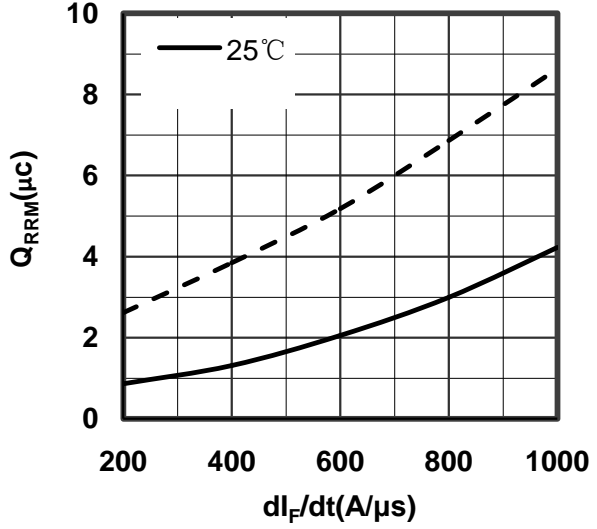


Figure 4. Reverse Recovery Charge vs di_F/dt

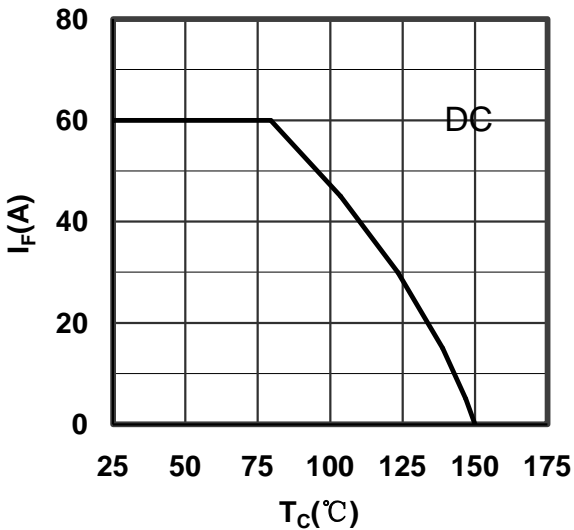


Figure 5. Forward current vs Case temperature

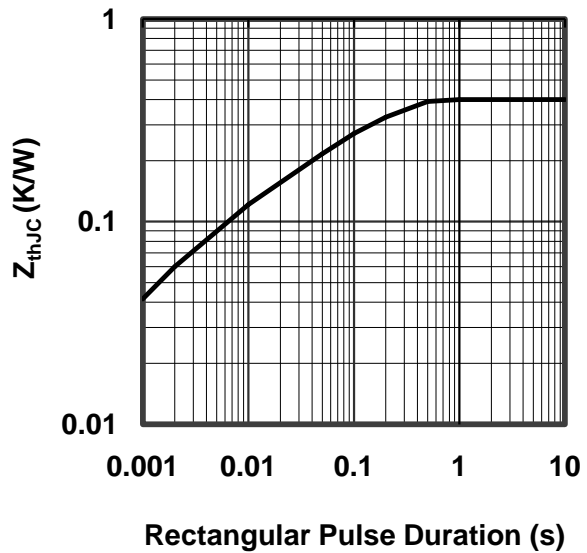


Figure 6. Transient Thermal Impedance

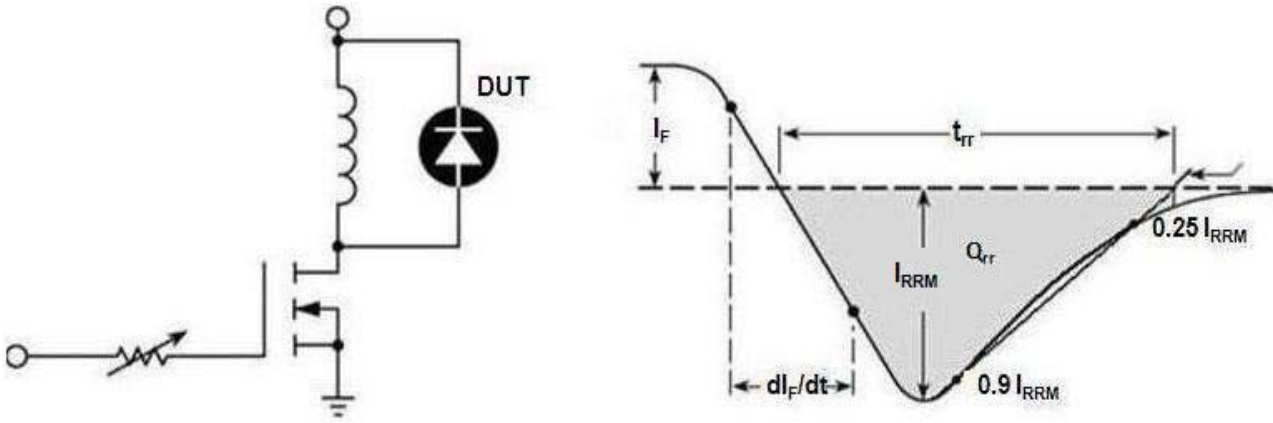
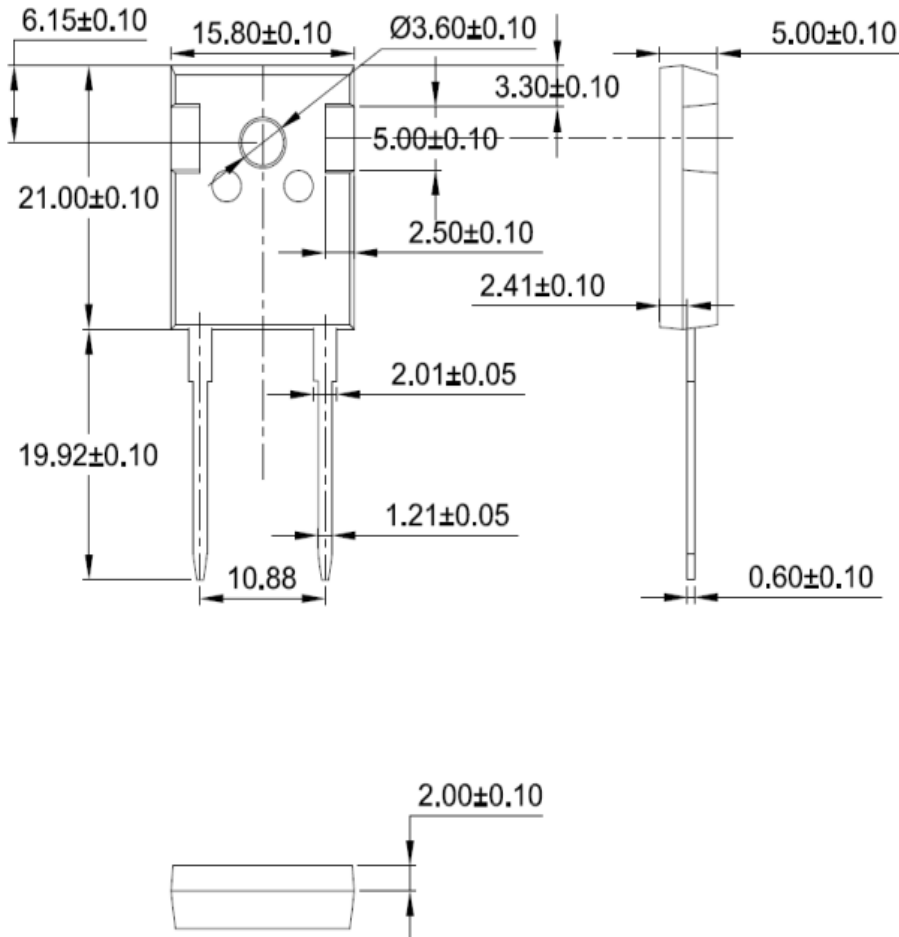


Figure 7. Diode Reverse Recovery Test Circuit and Waveform



Dimensions in (mm)
Figure 8. Package Outline